

J217-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)		
- 60	0.0160 at V _{GS} = - 10 V	- 53	38 nC		
	0.0200 at V _{GS} = - 4.5 V	- 42	30 110		

FEATURES

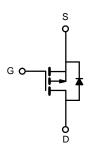
- Trench Power MOSFET
- 100 % UIS Tested

APPLICATIONS

· Load Switch







P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 60	V		
Gate-Source Voltage	V _{GS}	± 25			
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C		- 53 ^a	А	
	T _C = 70 °C	,	- 46.8		
	T _A = 25 °C	I _D	-9.2 ^b		
	T _A = 70 °C		- 8.1 ^b		
Pulsed Drain Current		I _{DM}	- 200	1	
Avalanche Current Pulse	L = 0.1 mH	I _{AS}	- 45		
Single Pulse Avalanche Energy		E _{AS}	101	mJ	
Continuous Source-Drain Diode Current	T _C = 25 °C	1	69 ^a	А	
Continuous Source-Drain Diode Current	T _A = 25 °C	l _S –	2.1 ^b		
	T _C = 25 °C		104.2 ^a		
Maximum Power Dissipation	T _C = 70 °C		66.7 ^a	14/	
	T _A = 25 °C	P _D	3.1 ^b	W	
	T _A = 70 °C		2 ^b		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	33	40	°C/W		
Maximum Junction-to-Case	Steady State	R _{thJC}	0.98	1.2]		

Notes:

- a. Based on T_C = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	$\Delta V_{DS}/T_{J}$ $I_{D} = -250 \mu A$		68		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 _D = - 230 μΑ		- 5.2		IIIV/ C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V			- 1		
		V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 55 °C			- 10	μA	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			Α	
Drain-Source On-State Resistance ^a	Б	V _{GS} = - 10 V, I _D = - 30 A		0.0160		Ω	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 20 A		0.0200			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S	
Dynamic ^b							
Input Capacitance	C _{iss}			3500		pF	
Output Capacitance	C _{oss}	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		390			
Reverse Transfer Capacitance	C _{rss}			290			
Total Cata Chausa	Qg	V _{DS} = - 30 V, V _{GS} = - 10 V, I _D = - 55 A		76	115		
Total Gate Charge				38	60	nC	
Gate-Source Charge	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -55 \text{ A}$		16			
Gate-Drain Charge	Q_{gd}			19			
Gate Resistance	R _g	f = 1 MHz		5.2		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	$V_{DD} = -2 \text{ V}, R_L = 2 \Omega$		7	15	- ns	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 10 A, V_{GEN} = - 10 V, R_g = 1 Ω		70	110		
Fall Time	t _f			40	60		
Drain-Source Body Diode Characteristic	s					L	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	_C = 25 °C		- 69	A	
Pulse Diode Forward Current ^a	I _{SM}				- 150		
Body Diode Voltage	V _{SD}	I _S = - 30 A		- 1	- 1.5	V	
Body Diode Reverse Recovery Time	t _{rr}	I _F = - 50 A, di/dt = 100 A/μs, T _J = 25 °C		45	68	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			59	120	nC	
Reverse Recovery Fall Time	t _a			29			
Reverse Recovery Rise Time	t _b			16		ns	

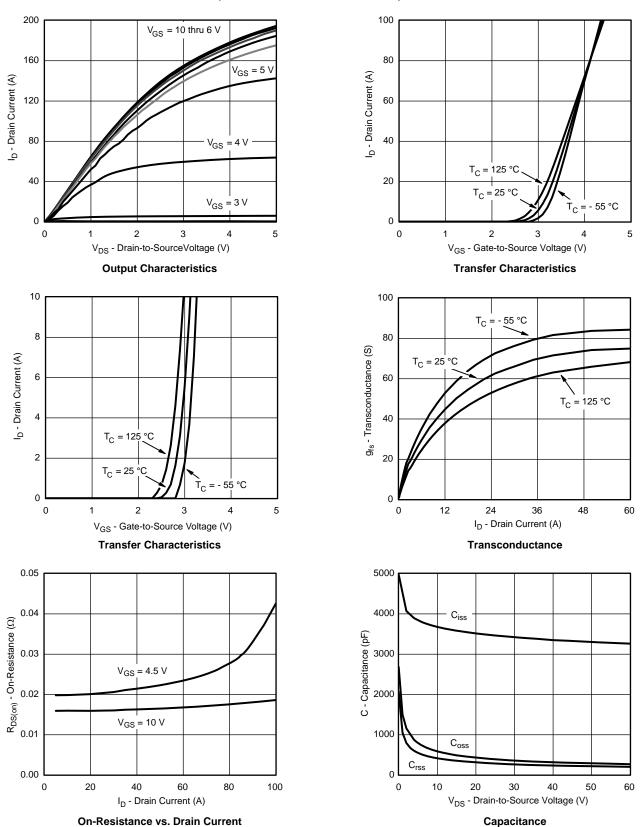
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

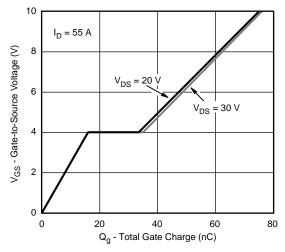


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

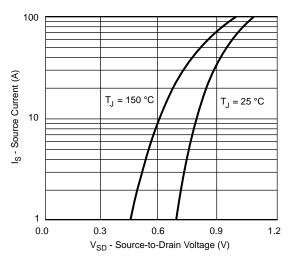




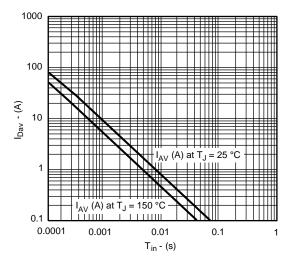
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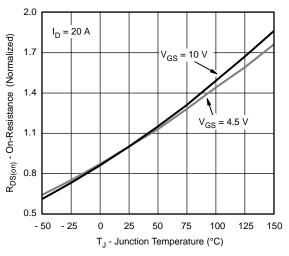
Gate Charge



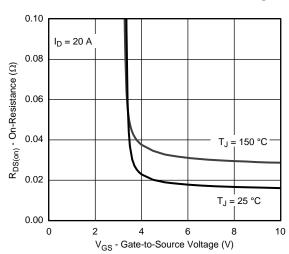
Source-Drain Diode Forward Voltage



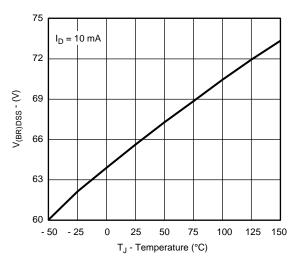
Single Pulse Avalanche Current Capability vs. Time



On-Resistance vs. Gate-to-Source Voltage



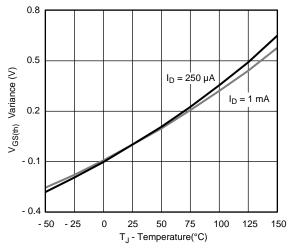
On-Resistance vs. Gate-to-Source Voltage

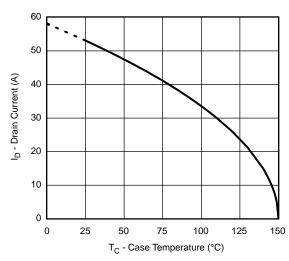


Drain-Source Breakdown Voltage vs. Junction Temperature

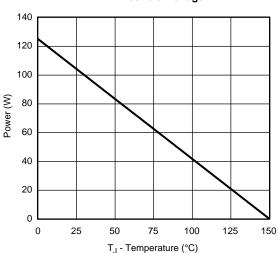


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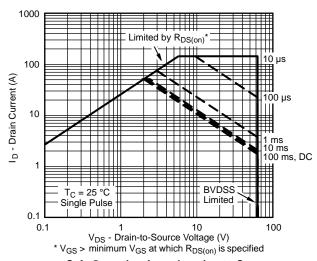




Threshold Voltage

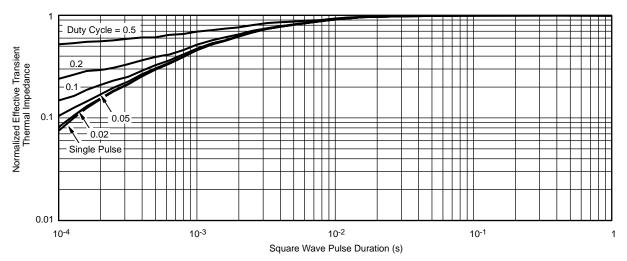


Max. Drain Current vs. Case Temperature



Power Derating, Junction-to-Case

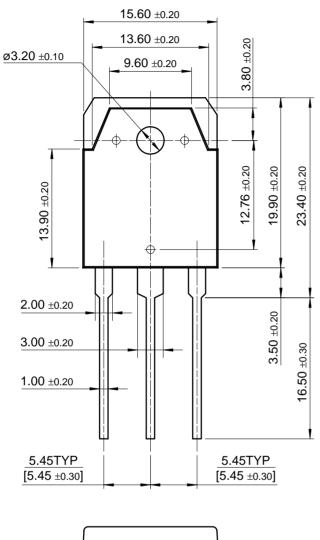


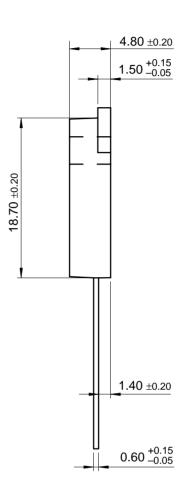


Normalized Thermal Transient Impedance, Junction-to-Case



TO-3P







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